

Declaration for U.S. Patent Application

ded inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

<u>C</u>

invention entitled	_	or of the subject ma	tter which is claimed and for	which a patent is sought on the
the specification	of which is attached hereto unle	ess the following is	checked	
	was filed on April 3, 2007 on 11/18/04 as PCT amended on (in	International Appl		
•	at I have reviewed and understand amendment referred to above.	nd the contents of	he above-identified specificat	tion, including the claim(s), as
I acknowledge the Regulations, § 1	ne duty to disclose information vo.56.	which is material to	patentability as defined in T	itle 37, Code of Federal
or inventor's cer	oreign priority benefits under Ti tificate listed below and have al ate before that of the application	so identified below	any foreign application for p	y foreign application(s) for patent patent or inventor's certificate
(List prior	JP2003-392875	Japan	21/11/2003	Priority Claimed Yes No
foreign	(Number)	(Country)	(Day/Month/Year Filed)	
applications. See note A on back of this page)	(Number) (Count	try) (Day/N	Month/Year Filed)	Yes No Yes No
	(Number) (Coun	ountry) (Day/Month/Year Filed)		Yes No
	(Number) (Count	try) (Day/N	Month/Year Filed)	
(See note B on b	ack of this page)	_ See attached list	for additional prior foreign a	applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List Prior U.S.			
Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)

	•	
I hereby claim priority	y benefits under Title 35, I	Jnited States Code, § 119 (e) of any provisional application(s) for patent listed below:
(List prior	•	
provisional applications.)	(Serial Number)	(Day/Month/Year Filed)
I hereby appoint the f Trademark Office con		or agent(s) to prosecute this application and to transact all business in the Patent and
		23850 PATENT & TRADEMARK OFFICE
Please direct all comm	nunications to the following	ng address:
		23850 PATENT & TRADEMARK OFFICE
belief are believed to like so made are puni	be true; and further that the shable by fine or imprisor	of my own knowledge are true and that all statements made on information and hese statements were made with the knowledge that willful false statements and the ament, or both, under Title 18 of the United States Code, § 1001 and that such dity of the application or any patent issued thereon.
Inventor's signature Residence Yonage	o-shi, Japan Division of Pharmacot Therapeutic Science, F	family name) MIURA, Norimasa Date June 24, 200 f Citizenship Japan herapeutics, Department of Patholophysiological and Caculty of Medicine, Tottori University, shi, Tottori 683-8503, Japan

Inventor's signature Residence ____ Post Office Address _

Full name of second inventor (given name, family name) SHIOTA, Goshi Inventor's signature Date Date

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